



# Data Sheet

| Customer:    |                   |
|--------------|-------------------|
| Part No:     | CL85I3311-C       |
| Sample No:   |                   |
| Description: | 3Ø Lamp IR Sensor |
| Item No:     |                   |

| Customer                       |  |  |  |  |  |
|--------------------------------|--|--|--|--|--|
| Check Inspection Approval Date |  |  |  |  |  |
|                                |  |  |  |  |  |





#### 1. Features

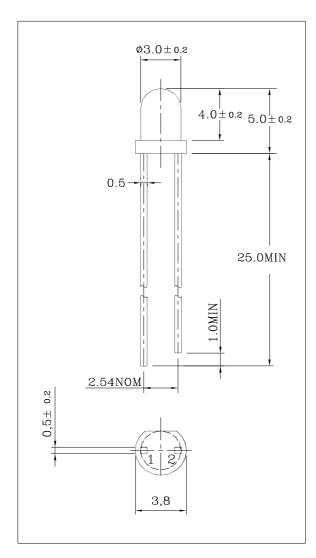
- ▶ Very highly efficient GaAlAs Chip.
- ▶ High reliability.
- ▶ High pulse handily capability.

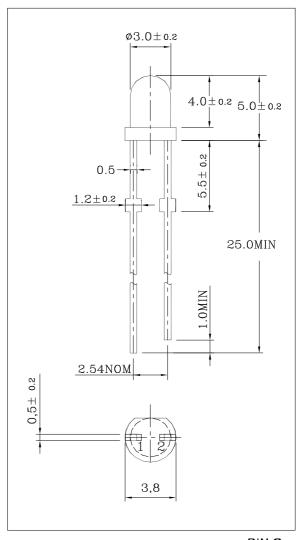
#### 2. Applications

- ▶ IR remote control for HIFI and TV sets, video tape recorders, dimmers.
- ▶ Light-reflection switches(max.500kHz).
- ▶ Coin counters. Sensor technology.
- ▶ Discrete opto couplers.

#### 3. Package Dimensions

Unit: mm





CL85I3311-C

CL85I3311-C(B)

PIN Connections

- 1. Anode
- 2. Cathode





# CL85I3311-C

## 4. Absolute maximum ratings

Ta=25℃

| Item                     | Symbol            | Ratings                 | Unit       |
|--------------------------|-------------------|-------------------------|------------|
| Forward Current          | ΙF                | 100                     | mA         |
| Pulse Forward Current *1 | ${ m I}_{\sf FP}$ | 500                     | mA         |
| Power Dissipation        | PD                | 150                     | mW         |
| Reverse Voltage          | VR                | 5                       | V          |
| Operating Temperature    | Topr              | -30~85                  | $^{\circ}$ |
| Storage Temperature      | T <sub>stg</sub>  | -30~100                 | °C         |
| Soldering Temperature *2 | Tsol              | <b>260</b> ± <b>5</b> ℃ | °C         |

<sup>\*1.</sup> Pulse Width=0.1msec, Duty ratio = 1/10

#### 5. Electrical Characteristics

Ta=25℃

| Item                             | Symbol              | <b>Test Condition</b> | Min | Тур | Max | Unit  |
|----------------------------------|---------------------|-----------------------|-----|-----|-----|-------|
| Forward Voltage                  | V <sub>F</sub>      | I <sub>F</sub> =50mA  | 1.3 | 1.6 | 1.7 | V     |
| Reverse Current                  | Ir                  | V <sub>R</sub> =5[V]  | -   | -   | 10  | μA    |
|                                  |                     | IF=50mA               | 20  | -   | 28  | mW∕sr |
| Radiant Intensity *3             | Ι <sub>Ε</sub>      |                       | 28  | -   | 40  |       |
|                                  |                     |                       | 40  | -   | 56  |       |
| Peak Wavelength                  | $\lambda_{P}$       | I <sub>F</sub> =50mA  | -   | 843 | -   | nm    |
| Spectrum Radiation<br>Band width | $\triangle \lambda$ | I <sub>F</sub> =50mA  | -   | 36  | -   | nm    |
| Viewing Angle                    | θ1/2                | I <sub>F</sub> =50mA  | -   | ±10 | -   | deg   |

<sup>\*3.</sup> This Value includes ±20% tolerance caused by Luminous Intensity measurement method of Ciellight Co.LTD

<sup>\*2. 5</sup> sec at location 2.0mm away from the base of the epoxy bulb.





#### 6. Characteristic Diagrams

Fig.1 I<sub>F</sub> - V<sub>F</sub>

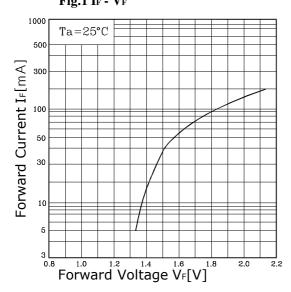


Fig.3 Spectrum Distribution

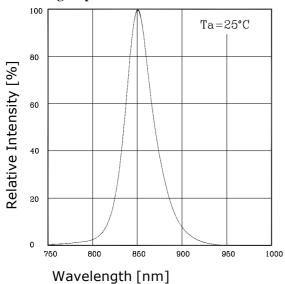


Fig.2 IF - Ta

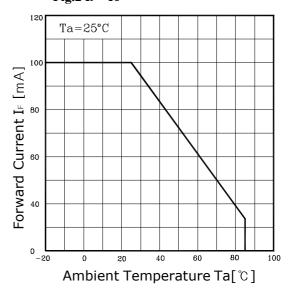
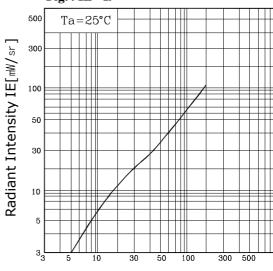
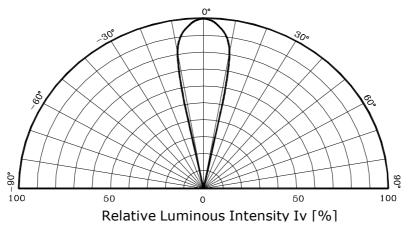


Fig.4 IE - IF



Forward Current [mA]

Fig.5 Radiation Characteristics







#### 7-1. Soldering counditions

(1) The LEDs can be soldered in place using the reflow soldering method.

Ciellight does not make any guarantee on the LEDs after they have been assembled using the dip soldering method.

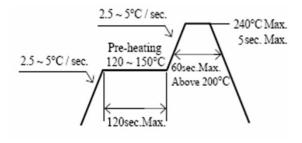
(2) Recommended soldering conditions

| Reflow Soldering |                    |                    | Hand Soldering |                 |  |
|------------------|--------------------|--------------------|----------------|-----------------|--|
|                  | Lead Solder        | Lead-free Solder   |                |                 |  |
| Pre-Heat         | 120~150℃           | 180~200°C          | ]              | 350°C Max.      |  |
| Pre-Heat Time    | 120sec Max.        | 120sec Max.        | Temperature    |                 |  |
| Peak Temperature | 240°C Max.         | 260°C Max.         | Soldering Time | (one time only) |  |
| Soldering Time   | 5sec Max.          | 5sec Max.          |                | (one time only) |  |
| Condition        | refer to profile ① | refer to profile ② |                |                 |  |

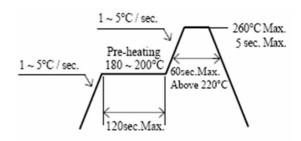
- \* Although the recommended soldering conditions are specified in the above table, reflow soldering at the lowest possible temperature is desirable for the LEDs.
- \* A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature. [Temperature-Profile (surface of circuit board)]

  Use the conditions shown to the following figures.

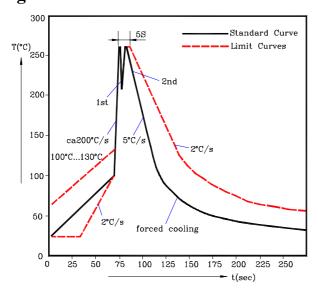
<1 : Lead Solder>



<②: Lead-free Solder>



## 7-2. TTW Soldering







#### 8-1. The Reliability criteria of LED Lamps

| Item               | Symbol           | Test Condition       | Limit        |              |  |
|--------------------|------------------|----------------------|--------------|--------------|--|
|                    | Syllibol         | rest condition       | Min          | Max          |  |
| Forward Voltage    | V <sub>F</sub>   | I <sub>F</sub> =50mA | -            | U.S.L. × 1.1 |  |
| Reverse Current    | $\mathbf{I}_{R}$ | V <sub>R</sub> =5V   | -            | U.S.L. × 2.0 |  |
| Luminous Intensity | Iv               | I <sub>F</sub> =50mA | L.S.L. × 0.7 | -            |  |

## 8-2. Results of Reliability Test

| NO | Item                                | Test Condition  | Test Hours/<br>Cycles | Sample<br>Size | Ac/Re |
|----|-------------------------------------|---|-----------------------|----------------|-------|
| 1  | Solder Heat                         | Temp: 260℃±5℃   | 5 SEC                 | 22 PCS         | 0/1   |
| 2  | Temperature Cycle                   | H:+100℃ 30min<br>∫ 5 min<br>L:-40℃ 30min                      | 100 CYCLE             | 22 PCS         | 0/1   |
| 3  | Thermal Shock                       | H: +100 $^{\circ}$ 5min<br>∫ 10 sec<br>L: -40 $^{\circ}$ 5min | 100 CYCLE             | 22 PCS         | 0/1   |
| 4  | High Temperature Storage            | Temp:85℃  | 1000 HRS              | 22 PCS         | 0/1   |
| 5  | Low Temperature Storage             | Temp:-30℃   | 1000 HRS              | 22 PCS         | 0/1   |
| 6  | Life Test                           | Ta=RT, $I_F$ = 20 mA  | 1000 HRS              | 22 PCS         | 0/1   |
| 7  | High Temperature /<br>High Humidity | Ta=85℃ / RH=85%   | 1000 HRS              | 22 PCS         | 0/1   |

<sup>\*</sup> This data is not results about this product , but results of another device used by similar raw materials.





#### 9. Caution on usage

- 9-1. Static electricity and surge will damage the LEDs It is recommended to take measures to prevent ESD problem (for example, grounding equipment and the human body, using grounded soldering iron and so on).
- 9-2. Be careful never to exceed, even momentarily, the absolute maximum ratings specified in the data sheet.
- 9-3. Ciellight will not be held responsible for any damage to the user that may result from accidents or any other reasons during operation of the user's unit ifuse to exceed the absolute maximum ratings, or not keep the matters that demand special attention.
  - 9-4. Store and use where there is no corrosive gas.
- 9-5. While the device is operational across the temperature range, functionality will with temperature. Specifications are stated only.
- 9-6. Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- 10. Warranty period : One year after delivery.